



Description

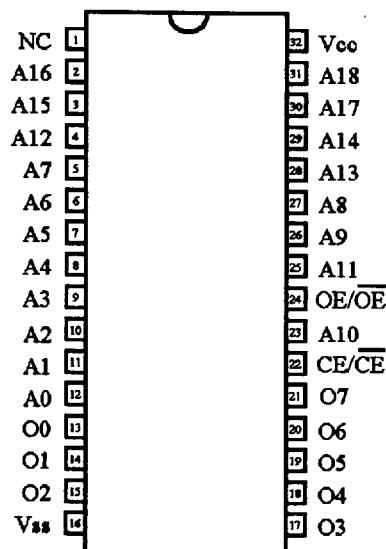
The GM23C4000B high performance read only memory is organized either as 524,288 x 8 bits and has an access time of 100/120/150ns. The GM23C4000B offers automatic power down controlled by the make programmed CE or \overline{CE} input. The low power feature allows the battery operation. An additional feature of GM23C4000B is the Output Enable. OE functions (may be mask programmed as OE/ \overline{OE}) in order to eliminate bus contention in multiple bus micro processor systems. The GM23C4000B is packaged in 32 pin DIP or 32pin SOP.

Features

- 524,288 x 8 bit Organization
- Single + 5V Supply
- Access Time : 100/120 / 150 ns (Max)
- Operating current : 50mA (Max)
- Standby current : 50 μ A (Max)
- TTL-compatible inputs and outputs
- Polarity programmable chip enable and out enable pin
- 3-State outputs for wired-OR expansion
- Fully static operation
- Package : GM23C4000BFW : 32 Pin Plastic SOP (525 mil)
GM23C4000B : 32Pin Plastic DIP (600 mil)

Pin Configuration

32 SOP/DIP



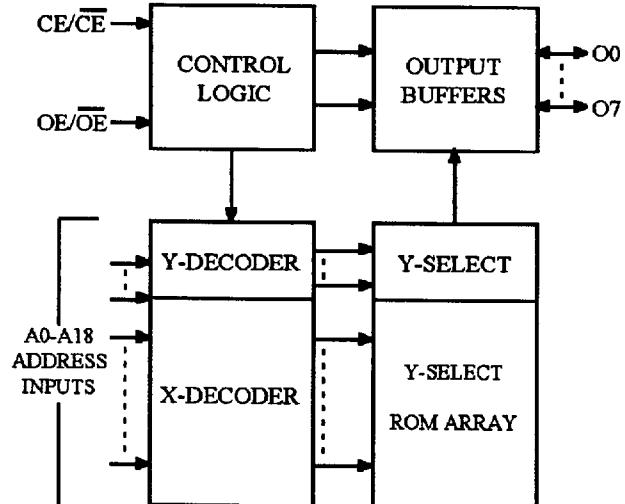
(Top View)

Pin Description

| Pin | Function |
|----------------------|---------------------|
| A0-A18 | Address Inputs |
| O0-O7 | Data Outputs |
| \overline{CE}/CE^* | Chip Enable Input |
| \overline{OE}/OE^* | Output Enable Input |
| Vcc | Power Supply (+5V) |
| Vss | Ground |
| N.C | No Connection |

*User Selectable Polarity.

Block Diagram





LG Semicon. Co., LTD.

Absolute Maximum Ratings*

| Symbol | Parameter | Rating | Unit |
|------------------|------------------------------------|------------------------------|------|
| T _A | Ambient Operating Temperature | -10 ~ 80 | °C |
| T _{STG} | Storage Temperature | -65 ~ 150 | °C |
| V _{CC} | Supply Voltage to Ground Potential | -0.5 ~ V _{CC} + 0.5 | V |
| V _{OUT} | Output Voltage | -0.5 ~ V _{CC} + 0.5 | V |
| V _{IN} | Input Voltage | -0.5 ~ 7.0 | V |

*Comments

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only functional operation of this device at these or any other conditions above those indicated in the operational sections of this specification is not implied and exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Recommended DC Operating Conditions (V_{CC} = 5.0V ± 10%, T_A = 0 ~ 70°C)

| Symbol | Parameter | Min | Typ | Max | Unit |
|-----------------|--------------------|------|-----|-----------------------|------|
| V _{CC} | Supply Voltage | 4.5 | 5.0 | 5.5 | V |
| V _{SS} | Supply Voltage | 0 | 0 | 0 | V |
| V _{IH} | Input High Voltage | 2.2 | - | V _{CC} + 0.3 | V |
| V _{IL} | Input Low Voltage | -0.3 | - | 0.8 | V |

DC Electrical Characteristics (V_{CC} = 5.0V ± 10%, T_A = 0 ~ 70°C)

| Symbol | Parameter | Condition | Min | Typ | Max | Unit |
|------------------|---------------------------------------------------|---------------------------------------------|-----|-----|-----|------|
| V _{OH} | Output High Voltage | I _{OH} = -1mA | 2.4 | | | V |
| V _{OL} | Output Low Voltage | I _{OL} = 2.1mA | | | 0.4 | V |
| I _{IL} | Input Leakage Current | V _{IN} = 0V to V _{CC} | | | ±10 | µA |
| I _{OL} | Output Leakage Current | V _{OUT} = 0V to V _{CC} | | | ±10 | µA |
| I _{CC} | Operating Supply Current (f = 6.7 MHz) Io=0 uA | CE = V _{IL} , CE = V _{IH} | | | 50 | mA |
| I _{SBI} | Standby Current (TTL) | CE = V _{IH} , all Output Open | | | 1 | mA |
| I _{SB2} | Standby Current (CMOS) | CE = V _{CC} , all Output Open | | | 50 | µA |

Capacitance (T_A = 25°C, f = 1.0 MHz)

| Symbol | Parameter | Condition | Min | Max | Unit |
|----------------|--------------------|-----------------------|-----|-----|------|
| C _I | Input Capacitance | V _{IN} = 0V | | 10 | pF |
| C _O | Output Capacitance | V _{OUT} = 0V | | 10 | pF |

Note : Capacitance is periodically sampled and not 100% tested.



Mode Selection

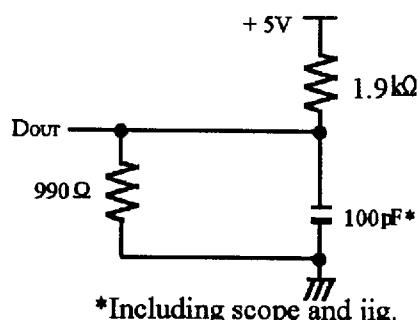
| CE/ \overline{CE} | OE/ \overline{OE} | Mode | DATA | Power |
|---------------------|---------------------|-----------|----------|---------|
| L/H | X | Standby | High-Z | Standby |
| H/L | L/H | Operating | High-Z | Active |
| | H/L | | Data Out | |

AC Operating Characteristics ($V_{CC} = 5.0V \pm 10\%$, $T_A = 0 \sim 70^\circ C$)

| Symbol | Parameter | GM23C4000B-10 | | GM23C4000B-12 | | GM23C4000B-15 | | Unit |
|------------------------|-----------------------------------------|---------------|-----|---------------|-----|---------------|-----|------|
| | | Min | Max | Min | Max | Min | Max | |
| t_{RC} | Read Cycle Time | 100 | | 120 | | 150 | | ns |
| t_{ACE} | Chip Enable Access Time | | 100 | | 120 | | 150 | ns |
| t_{AA} | Address Access Time | | 100 | | 120 | | 150 | ns |
| t_{AOE} | Output Enable Access Time | | 50 | | 60 | | 70 | ns |
| t_{OH} | Output Hold From Address Change | 0 | | 0 | | 0 | | ns |
| t_{OHZ} t_{CHZ} | Output or Chip Disable to Output High-Z | | 40 | | 50 | | 60 | ns |
| t_{OLZ} t_{CLZ} | Output or Chip Enable to Output Low-Z | 10 | | 10 | | 10 | | ns |

AC Test Condition

| | |
|-------------------------------|--------------|
| Input Pulse Level | 0.4V to 2.4V |
| Input Rise and Fall Time | 10ns |
| Input and Output Timing Level | 0.8V to 2.0V |
| Output Load | See Fig. 1 |



*Including scope and jig.

Fig. 1 Output Load Circuit



Mode Selection

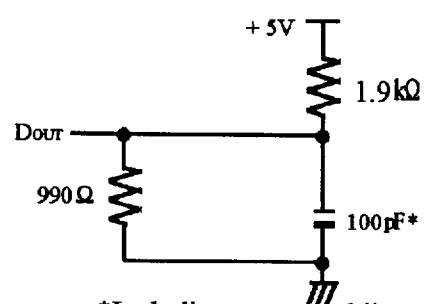
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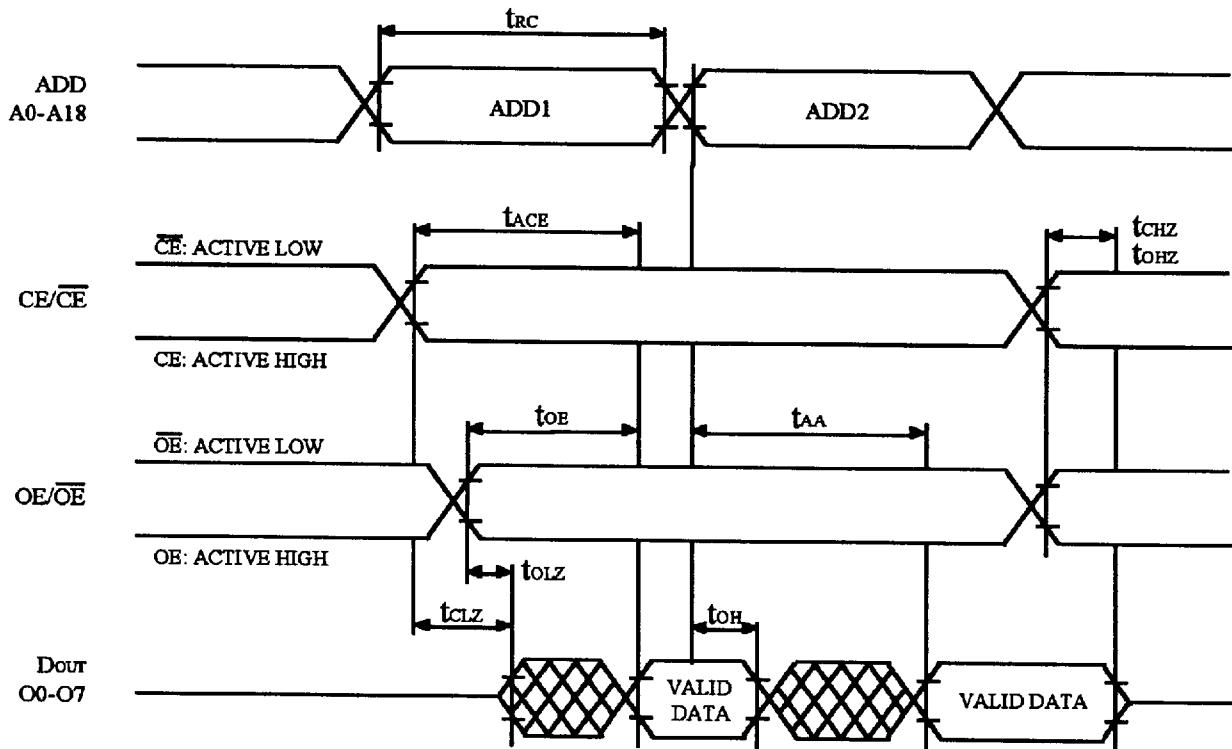
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Fig. 1 Output Load Circuit



Timing Waveforms

Read

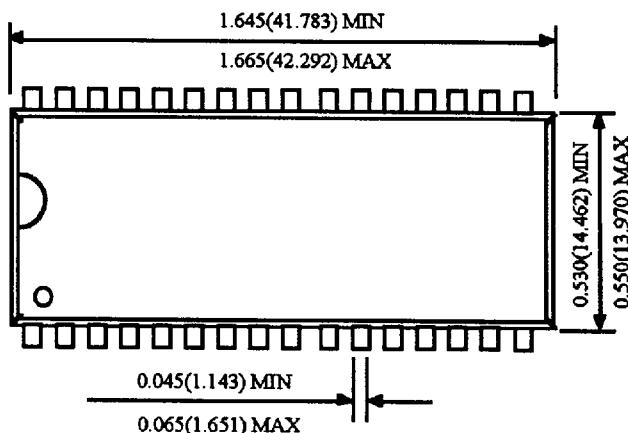




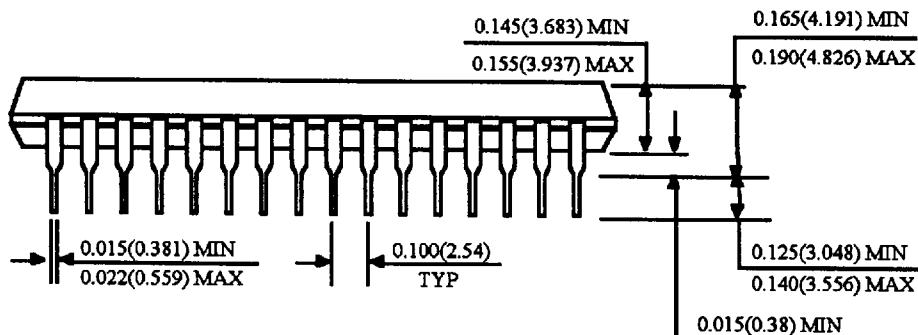
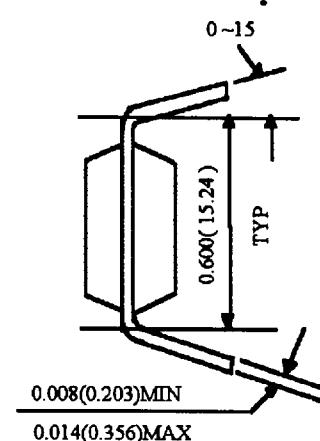
LG Semicon. Co., LTD.

Package Dimensions

32 DIP



Unit: Inches (mm)



32 SOP

